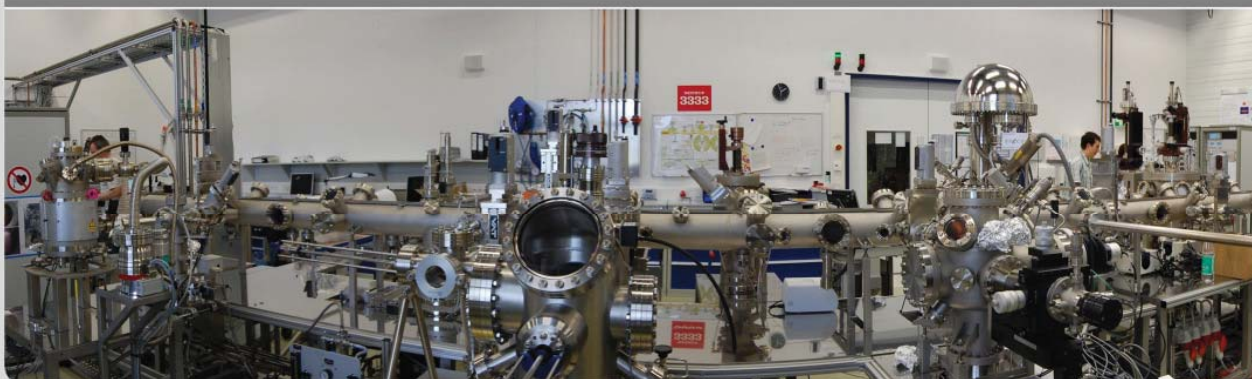


In situ control of the structure formation of magnetron sputtered Vanadium Carbide coatings: periodic modulation of the microstructure

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KIT – University of the State of Baden-Württemberg and
National Large-scale Research Center of the Helmholtz Association

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Motivation

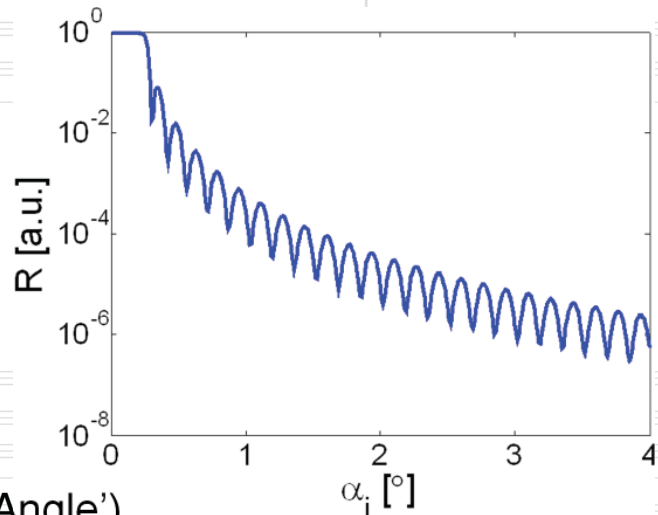
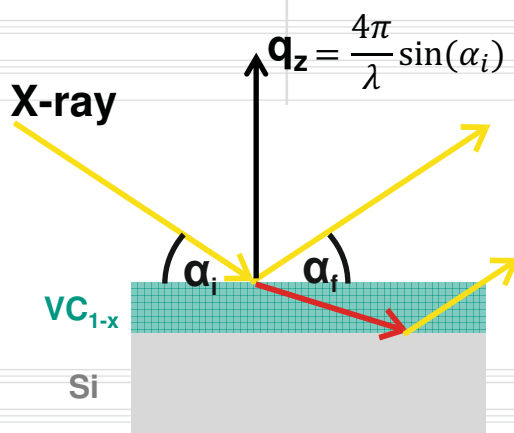
- Hard coating materials
 - Enhance life time of tools, artificial medical implants ...
- Multilayer systems
 - Tailoring of e.g. optical, tribological, mechanical properties
 - Alternating layers of **two** materials (e.g. **two** different average densities)

New approach:

Growth conditions can influence the average density of a single layer
Is it possible to grow a “one-material” multilayer?

 *In situ* X-ray reflectivity study during growth

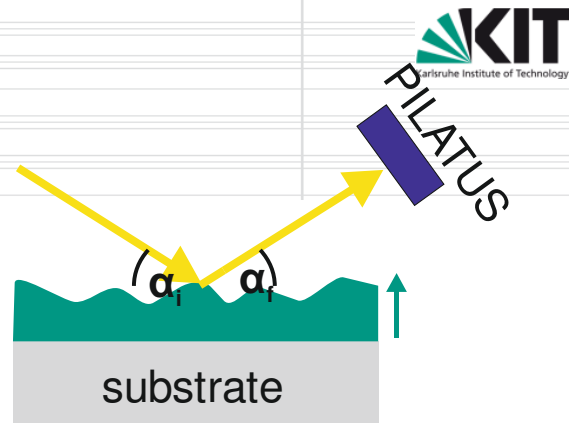
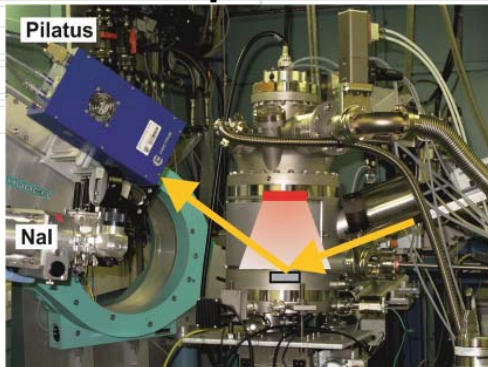
Basics of X-Ray Reflectivity



- **Electron density** ('Critical Angle')
- **Thickness** ('Kiessig fringes'): $D = \frac{2\pi}{\Delta q_z}$
- **Roughness** ('Slope')

[1] Pietsch, Holy, Baumbach, *High Resolution X-Ray Scattering from thin films and lateral Nanostructures*, Springer 2004

In situ: Experimental Setup

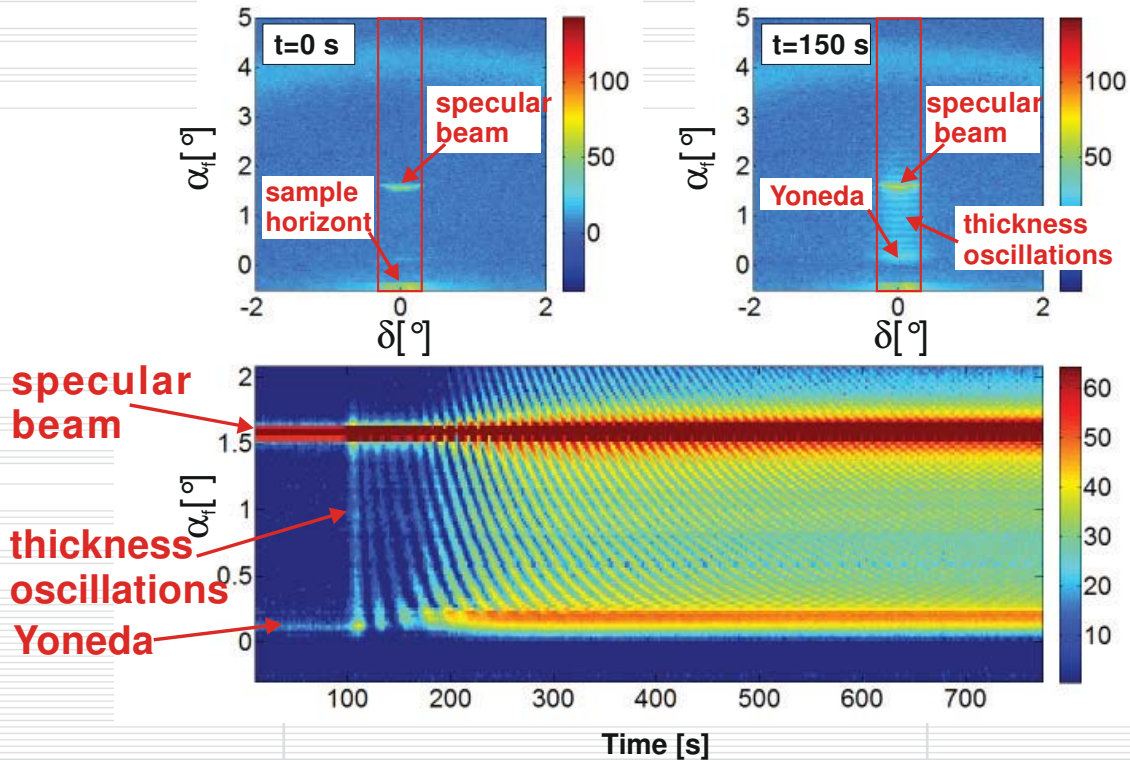


- **Sputter conditions: [1]**
 - Target: Vanadium Carbide
 - Substrate: Si(100) with natural oxide
 - Target-substrate Distance: 10 cm
 - Argon Pressure: 2×10^{-3} mbar
 - Fully automatized sputtering process
 - 0.22 nm/s at DC Power 200 W

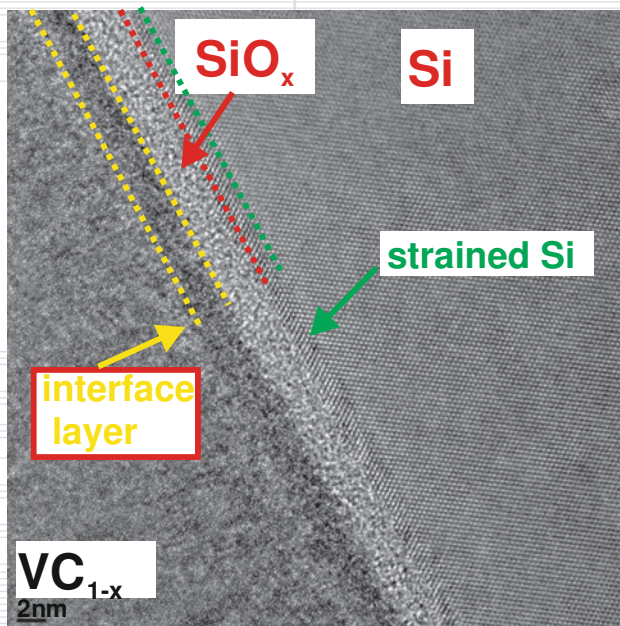
- **Setup @ MPI-Beamline:**
 - Energy: 10 keV
 - Beamsize: 300µm x 200µm
 - XRR measurements at fixed angular position: $\alpha_i = \alpha_f = 1.6^\circ$
 - Detector: Pilatus 100K

[1] Krause et al., *J. Synchrotron Rad.* (2012), **19**, 216-222

Pilatus measurements at $\alpha_i = \alpha_f = 1.6^\circ$



TEM Analysis *after growth*



- Vanadium Carbide on Silicon
- DC Power: 50 W
- Room Temperature
- Bilayer system:
 - **Growth of dense interface layer**
- *In situ* XRR measurements:
 - High pressure leads to dense growth

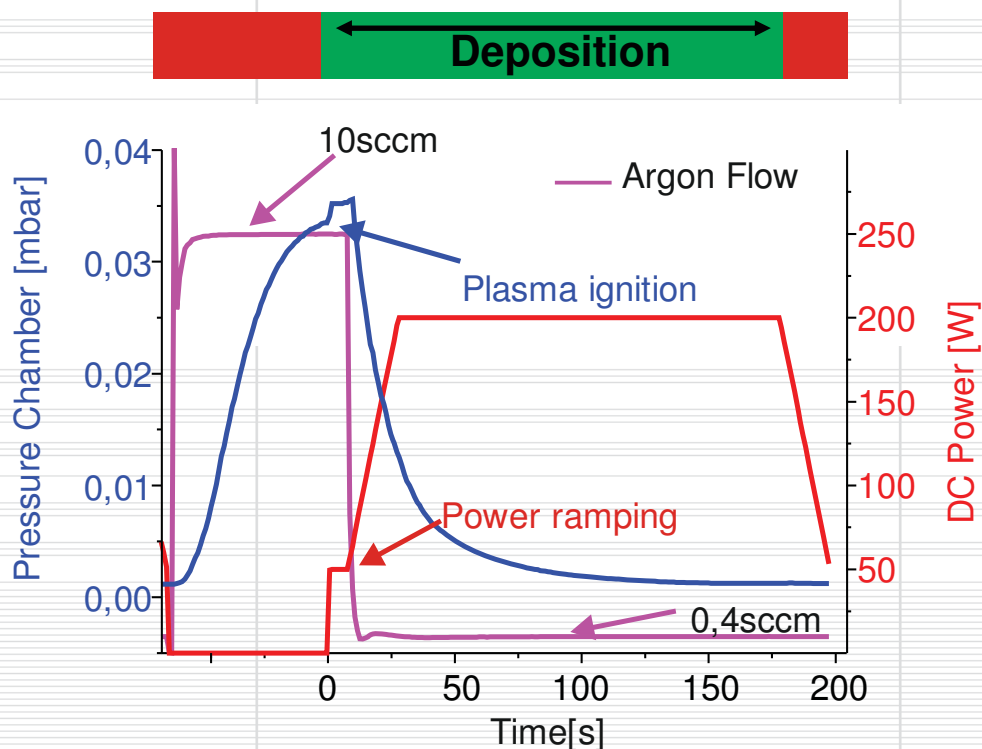
Possibility to grow multilayer of one material!

■ Idea:

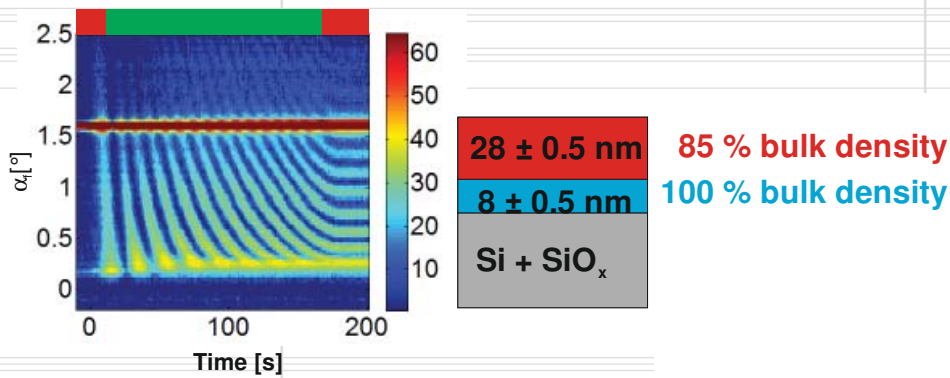
- Grow bilayer by pressure variation (high/low pressure)
- Thickness of Bilayer: 35 nm
- Deposition Time: 180s @ DC Power: 200W

➔ Repeating this process: Achieve a multilayer structure

Multilayer by interrupted deposition: Sputtering conditions

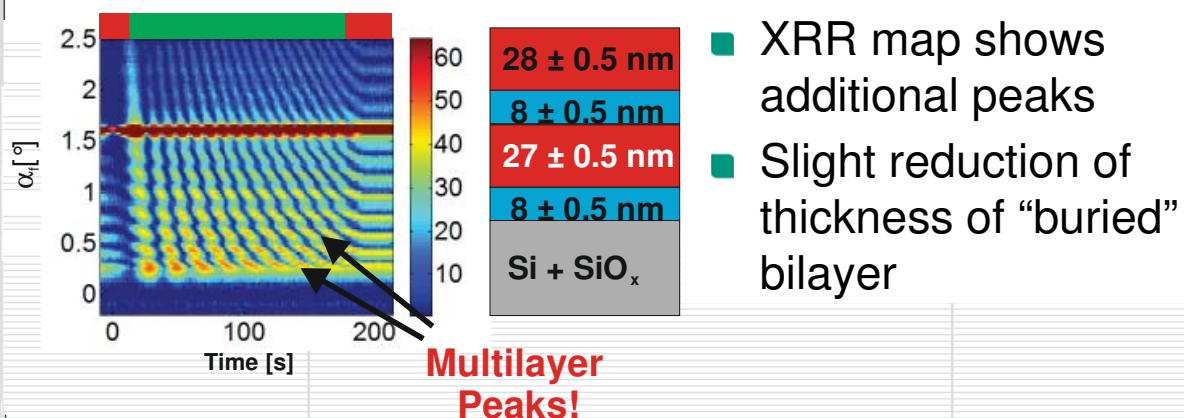
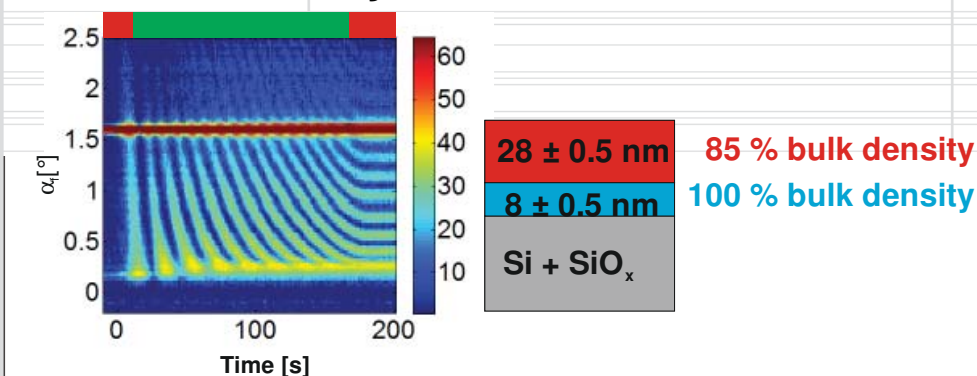


In situ Reflectivity: Period 1



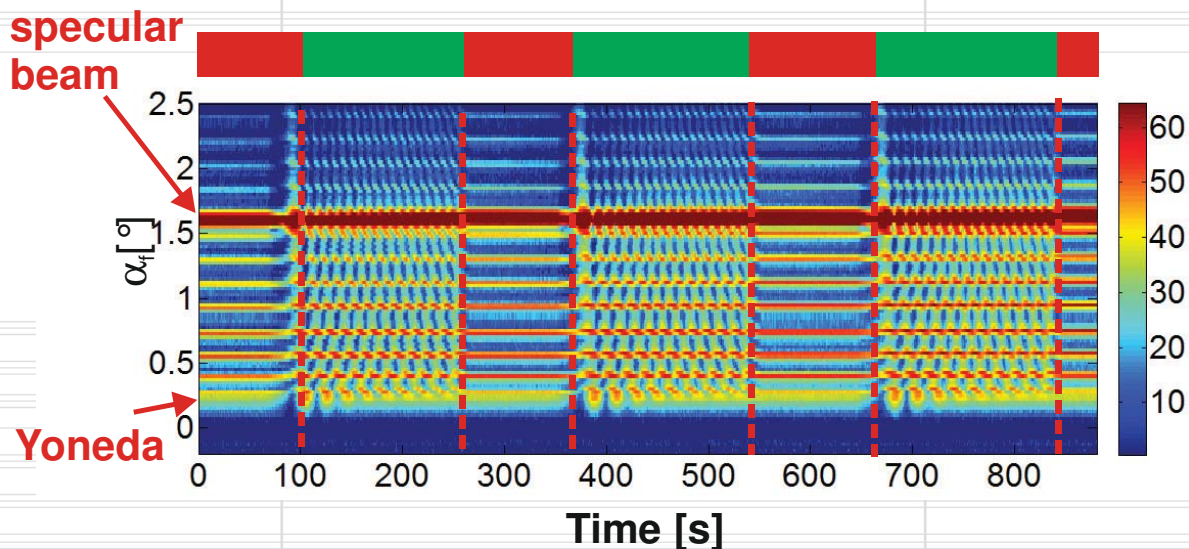
- XRR map like “normal” deposition
- Detailed Analysis: Growth of bilayer system!

In situ Reflectivity: Period 1 and 2



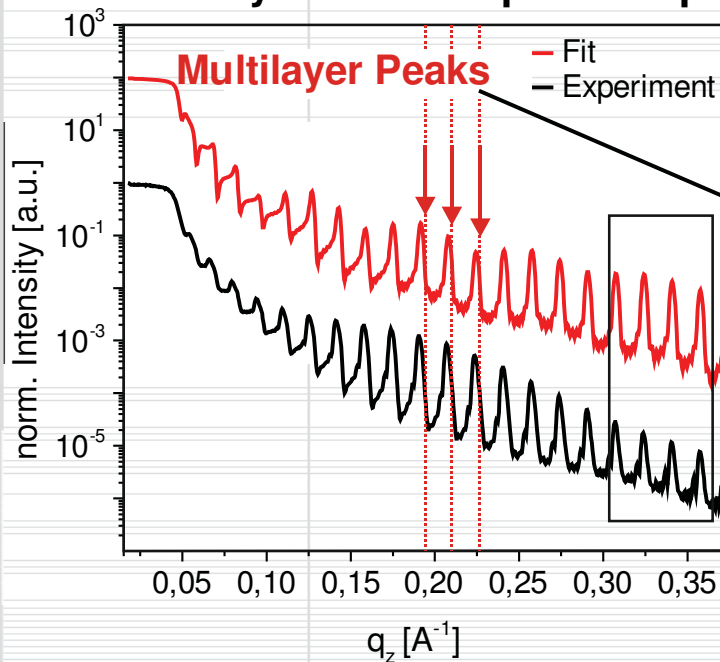
- XRR map shows additional peaks
- Slight reduction of thickness of “buried” bilayer

Multilayer by interrupted deposition: *in situ* Reflectivity Periods 5-7



Growth of periodic structure!

Multilayer by interrupted deposition: Reflectivity after 7th deposition period

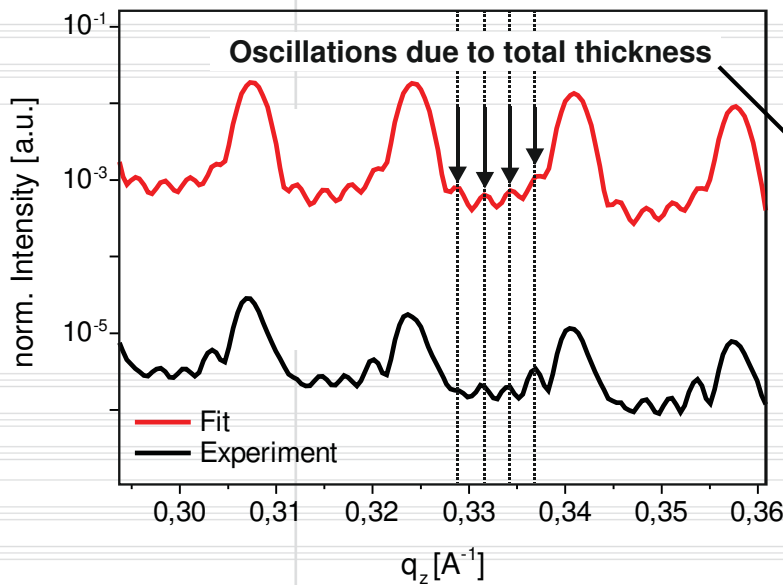


Thickness of one bilayer:
 35 ± 0.75 nm

85 % bulk density
100 % bulk density

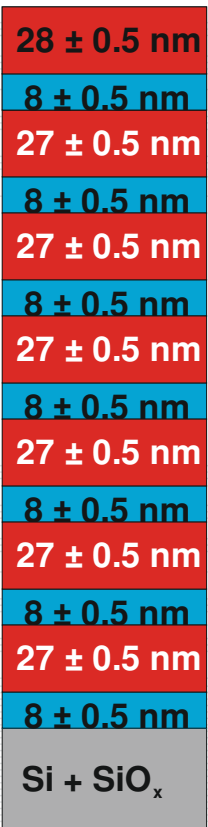
28 ± 0.5 nm
8 ± 0.5 nm
27 ± 0.5 nm
8 ± 0.5 nm
27 ± 0.5 nm
8 ± 0.5 nm
27 ± 0.5 nm
8 ± 0.5 nm
27 ± 0.5 nm
8 ± 0.5 nm
27 ± 0.5 nm
8 ± 0.5 nm
27 ± 0.5 nm
8 ± 0.5 nm
27 ± 0.5 nm
8 ± 0.5 nm
27 ± 0.5 nm
8 ± 0.5 nm
Si + SiO _x

Multilayer by interrupted deposition: Reflectivity after 7th deposition period



Total thickness
after deposition of 7 bilayers:
 245 ± 1 nm

85 % bulk density
100 % bulk density



Summary

- Successful growth of multilayer systems of one material by variation of the gas pressure
 - Periodical modulation of the microstructure of single material
- Monitoring of the multilayer formation by *in situ* X-ray reflectivity measurements
 - Non-destructive investigation of the average density of the microstructure during growth
 - Sensitive to temporal changes of buried layers during deposition
- Multilayer system growth by a simple deposition process

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Thank You for Your Attention !